

54LS365A,DM54LS365A,DM74LS365A

54LS365A DM54LS365A DM74LS365A Hex TRI-STATE(RM) Buffers



Literature Number: SNOS304A

54LS365A/DM54LS365A/DM74LS365A Hex TRI-STATE® Buffers

General Description

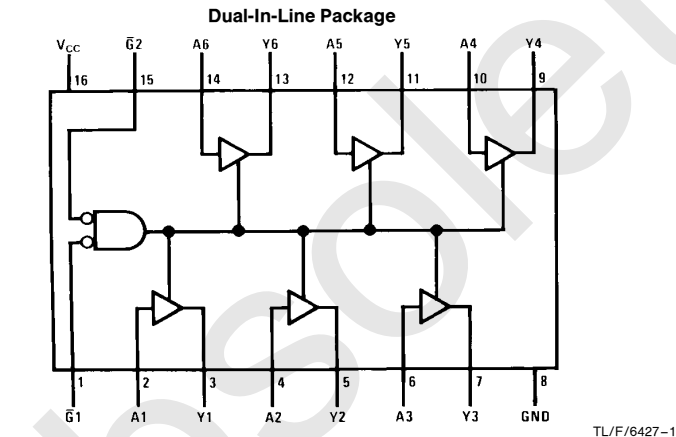
This device contains six independent gates each of which performs a non-inverting buffer function. The outputs have the TRI-STATE feature. When enabled, the outputs exhibit the low impedance characteristics of a standard LS output with additional drive capability to permit the driving of bus lines without external resistors. When disabled, both the output transistors are turned off presenting a high-impedance state to the bus line. Thus the output will act neither as a significant load nor as a driver. To minimize the possibility

that two outputs will attempt to take a common bus to opposite logic levels, the disable time is shorter than the enable time of the outputs.

Features

- Alternate Military/Aerospace device (54LS365A) is available. Contact a National Semiconductor Sales Office/Distributor for specifications.

Connection Diagram



Order Number 54LS365ADMQB, 54LS365AFMQB, 54LS365ALMQB,
DM54LS365AJ, DM54LS365AW, DM74LS265AM or DM74LS365AN
See NS Package Number E20A, J16A, M16A, N16E or W16A

Function Table

$$Y = A$$

Input			Output
$\bar{G}1$	$\bar{G}2$	A	Y
H	X	X	Hi-Z
X	H	X	Hi-Z
L	L	H	H
L	L	L	L

H = High Logic Level

L = Low Logic Level

X = Either Low or High Logic Level

Hi-Z = TRI-STATE (Outputs are disabled)

TRI-STATE® is a registered trademark of National Semiconductor Corporation.

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	
DM54LS and 54LS	−55°C to +125°C
DM74LS	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	DM54LS365A			DM74LS365A			Units
		Min	Nom	Max	Min	Nom	Max	
V _{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High Level Input Voltage	2			2			V
V _{IL}	Low Level Input Voltage			0.7			0.8	V
I _{OH}	High Level Output Current			−1			−2.6	mA
I _{OL}	Low Level Output Current			12			24	mA
T _A	Free Air Operating Temperature	−55		125	0		70	°C

Electrical Characteristics over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 1)	Max	Units
V _I	Input Clamp Voltage	V _{CC} = Min, I _I = −18 mA			−1.5	V
V _{OH}	High Level Output Voltage	V _{CC} = Min, I _{OH} = Max V _{IL} = Max, V _{IH} = Min	2.4	3.4		V
V _{OL}	Low Level Output Voltage	V _{CC} = Min, I _{OL} = Max V _{IL} = Max, V _{IH} = Min	DM54	0.25	0.4	V
			DM74	0.35	0.5	
		I _{OL} = 12 mA, V _{CC} = Min	DM74	0.25	0.4	
I _I	Input Current @ Max Input Voltage	V _{CC} = Max, V _I = 7V			0.1	mA
I _{IH}	High Level Input Current	V _{CC} = Max, V _I = 2.7V			20	μA
I _{IL}	Low Level Input Current	V _{CC} = Max, V _I = 0.5V (Note 4)	A Input		−20	μA
		V _{CC} = Max, V _I = 0.4V (Note 5)	A Input		−0.4	mA
		V _{CC} = Max, V _I = 0.4V	$\bar{G}$ Input		−0.4	
I _{OZH}	Off-State Output Current with High Level Output Voltage Applied	V _{CC} = Max, V _O = 2.4V V _{IH} = Min, V _{IL} = Max			20	μA
I _{OZL}	Off-State Output Current with Low Level Output Voltage Applied	V _{CC} = Max, V _O = 0.4V V _{IH} = Min, V _{IL} = Max			−20	μA
I _{OS}	Short Circuit Output Current	V _{CC} = Max (Note 2)	DM54	−20	−100	mA
			DM74	−20	−100	
I _{CC}	Supply Current	V _{CC} = Max (Note 3)		14	24	mA

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 2: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Note 3: I_{CC} is measured with the DATA inputs grounded and the OUTPUT CONTROLS at 4.5V.

Note 4: Both $\bar{G}$ inputs are at 2V.

Note 5: Both $\bar{G}$ inputs at 0.4V.

Switching Characteristics at $V_{CC} = 5V$ and $T_A = 25^\circ C$ (See Section 1 for Test Waveforms and Output Load)

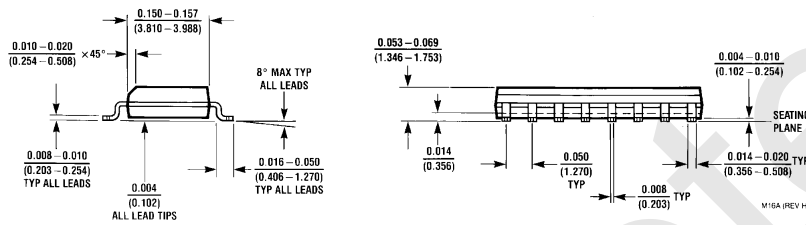
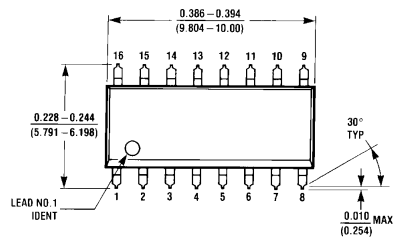
Symbol	Parameter	$R_L = 667\Omega$				Units
		$C_L = 50\text{ pF}$		$C_L = 150\text{ pF}$		
		Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time Low to High Level Output		16		25	ns
t_{PHL}	Propagation Delay Time High to Low Level Output		16		25	ns
t_{PZH}	Output Enable Time to High Level Output		30		40	ns
t_{PZL}	Output Enable Time to Low Level Output		30		40	ns
t_{PHZ}	Output Disable Time from High Level Output (Note 6)		20			ns
t_{PLZ}	Output Disable Time from Low Level Output (Note 6)		20			ns

Note 6: $C_L = 5\text{ pF}$.

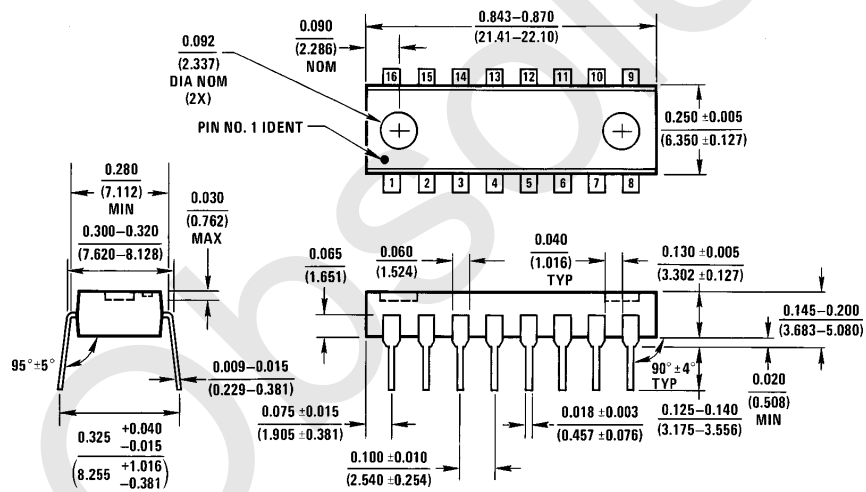
The drawing shows a 16-pin connector housing with the following dimensions:

- Top View:**
 - Overall width: 0.350 ± 0.008 (8.890 $\pm$ 0.203)
- Side View:**
 - Overall height: $0.063 - 0.075$ (1.600 - 1.905)
 - Detail A points to the pin area.
- Bottom View:**
 - Pin pitch (center-to-center): 0.200 ± 0.005 (5.080 $\pm$ 0.127) TYP
 - Pin width: 0.015 (0.381) MIN TYP
 - Pin height: $0.077 - 0.093$ (1.959 - 2.362)
 - Pin thickness: $0.045 - 0.055$ (1.143 - 1.397) TYP
 - Pin #1 Index: $0.067 - 0.083$ (1.702 - 2.108) TYP
 - Pin #1 Index width: $0.045 - 0.055$ (1.143 - 1.397) TYP
 - Pin #1 Index height: $0.022 - 0.028$ (0.559 - 0.711) TYP
 - Pin #1 Index width: $0.007 - 0.011$ (0.178 - 0.279) R TYP
 - Pin #1 Index height: 0.015 ± 0.010 (0.381 $\pm$ 0.254) $45^\circ \times$
 - Pin #1 Index width: 0.040 ± 0.010 (1.016 $\pm$ 0.254) 3 PLCS $45^\circ \times$

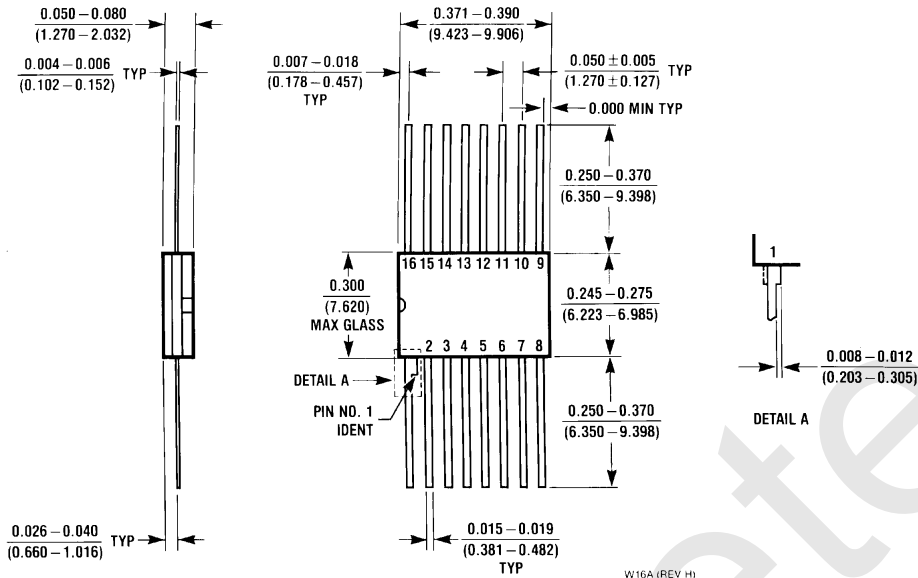
Physical Dimensions inches (millimeters) (Continued)



16-Lead Small Outline Molded Package (M)
Order Number DM74LS365AM
NS Package Number M16A



16-Lead Molded Dual-In-Line Package (N)
Order Number DM74LS365AN
NS Package Number N16E

Physical Dimensions inches (millimeters) (Continued)

16-Lead Ceramic Flat Package (W)
Order Number 54LS365AFMQB or DM54LS365AW
NS Package Number W16A

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